



RD Number: RD194

RD Title: TC78B027FTG/TMPM373FWDUG Fan Motor Drive Board BOM

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	U1	1	TC78B027FTG	TC78B027FTG	TOSHIBA	Motor driver IC	VQFN24	
2	U6	1	HW-101A	—	—	Hall element		
3	U8	1	TMPM373FWDUG	TMPM373FWDUG	TOSHIBA	Microcontroller	LQFP48	
4	D2	1	Zener Diode	—	—	Zener Diode 13V		
5	D3	1	FM240-MH-H	—	—	Schottky Barrier Rectifier		
6	Q1	1	SSM6K513NU	SSM6K513NU	TOSHIBA	MOSFET	UDFN6B	
7	Q2	1	SSM6K513NU	SSM6K513NU	TOSHIBA	MOSFET	UDFN6B	
8	Q3	1	SSM6K513NU	SSM6K513NU	TOSHIBA	MOSFET	UDFN6B	
9	Q4	1	SSM6K513NU	SSM6K513NU	TOSHIBA	MOSFET	UDFN6B	
10	Q9	1	SSM6K513NU	SSM6K513NU	TOSHIBA	MOSFET	UDFN6B	
11	Q10	1	SSM6K513NU	SSM6K513NU	TOSHIBA	MOSFET	UDFN6B	
12	C1	1	0.1 $\mu$ F 25V	—	—	Chip capacitor		
13	C2	1	0.01 $\mu$ F 50V	—	—	Chip capacitor		
14	C6	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
15	C7	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
16	C8	1	10 $\mu$ F 25V	—	—	Chip capacitor		
17	C9	1	22 $\mu$ F 25V	—	—	Chip capacitor		
18	C10	1	0.1 $\mu$ F 25V	—	—	Chip capacitor		
19	C11	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
20	C12	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
21	C13	1	0.1 $\mu$ F 25V	—	—	Chip capacitor		
22	C14	1	0.1 $\mu$ F 25V	—	—	Chip capacitor		
23	C16	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
24	C17	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
25	C18	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
26	C21	1	0.1 $\mu$ F 16V	—	—	Chip capacitor		
27	C28	1	4.7 $\mu$ F 16V	—	—	Chip capacitor		
28	C29	1	4.7 $\mu$ F 16V	—	—	Chip capacitor		
29	R1	1	50m $\Omega$	—	—	Chip resistor		
30	R2	1	50m $\Omega$	—	—	Chip resistor		
31	R3	1	4.7k $\Omega$	—	—	Chip resistor		
32	R4	1	1k $\Omega$	—	—	Chip resistor		
33	R5	0	Not mount	—	—	Chip resistor		✓



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